UNITED STATES SECURITIES AND EXCHANGE COMMISSION

WASHINGTON, DC 20549

FORM 8-K CURRENT REPORT

Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

> May 6, 2003 (Date of earliest event reported)

TTM TECHNOLOGIES, INC.

(Exact Name of Registrant as Specified in Charter)

WASHINGTON

(State or other jurisdiction of incorporation)

0-31285 (Commission File Number)

91-1033443 (IRS Employer Identification Number)

2630 SOUTH HARBOR BOULEVARD SANTA ANA, CALIFORNIA 92704

(Address of Principal Executive Offices) (Zip Code)

(714) 327-3000

(Registrant's telephone number, including area code)

Item 9. Regulation FD Disclosure.

The Company is furnishing this Report on Form 8-K pursuant to Regulation FD in connection with the disclosure of textual information from a slide show presentation given at the IPC Technology Market Research Council Conference on May 6, 2003.

The information in this Report on Form 8-K (including the exhibit) is furnished pursuant to Item 9 and shall not be deemed to be "filed" for the purpose of Section 18 of the Securities Exchange Act of 1934 or otherwise subject to the liabilities of that section. This Report will not be deemed an admission as to the materiality of any information in the report that is required to be disclosed solely by Regulation FD.

The Company does not have, and expressly disclaims, any obligation to release publicly any updates or any changes in the Company's expectations or any change in events, conditions, or circumstances on which any forward-looking statement is based.

The information included with this Report includes slides used in the presentation. The slides will also be available for viewing at our website located at www.ttmtech.com, although we reserve the right to discontinue that availability at any time.

EXHIBITS

Date: May 7, 2003

Exhibit 99.1 TTM Technologies, Inc. Presentation at theIPC Technology Market Research Council Conference on May 6, 2003.

2

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

TTM TECHNOLOGIES, INC.

By: /s/ STACEY M. PETERSON

Stacey M. Peterson Chief Financial Officer







TTM Technologies

During the course of this presentation, we will make projections or other forward-looking statements regarding future events or the future financial performance of the Company. We wish to caution you that such statements reflect only our current expectations, and that actual events or results may differ materially.

We refer you to the risk factors and cautionary language contained in the documents that the Company files from time to time with the Securities and Exchange Commission, specifically the Company's 10-K for our last fiscal year ended December 31, 2002. Such documents contain and identify important factors that could cause the actual results to differ materially from those contained in our projections or forward-looking statements. We undertake no obligation to update such projections or such forward-looking statements in the future.

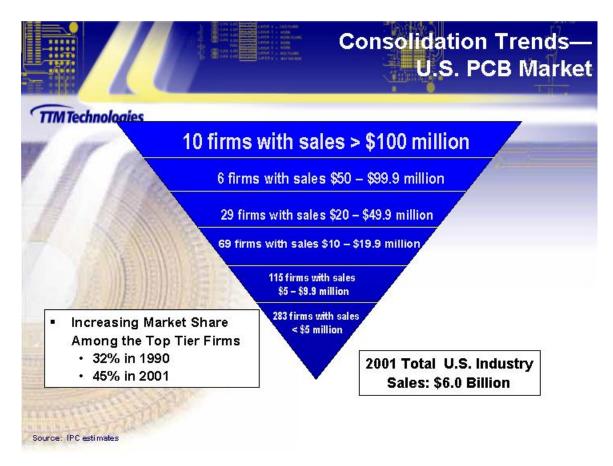
For your convenient reference, a copy of this presentation on Form 8-K has been filed with the Securities and Exchange Commission and will be posted on our website.



North American PCB Market Challenging Industry Trends TIMTechnologies Prolonged downturn in Diversified customer base -

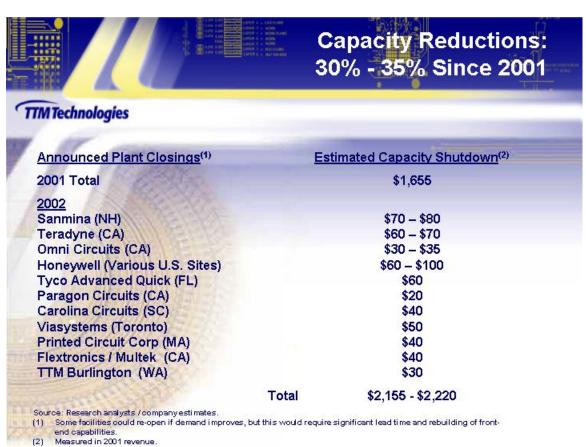
- Prolonged downturn in electronics industry
- Increased competition
- Capacity reduction / consolidation
- North American PCB market transitioning to high mix, high complexity
- Several companies
 experiencing liquidity
 constraints / solvency issues

- Diversified customer base well positioned for recovery
- Focus on cost management and operational efficiency
- Remaining competitors gaining customers / share
- Differentiation through technology and service
- Well capitalized players capturing share

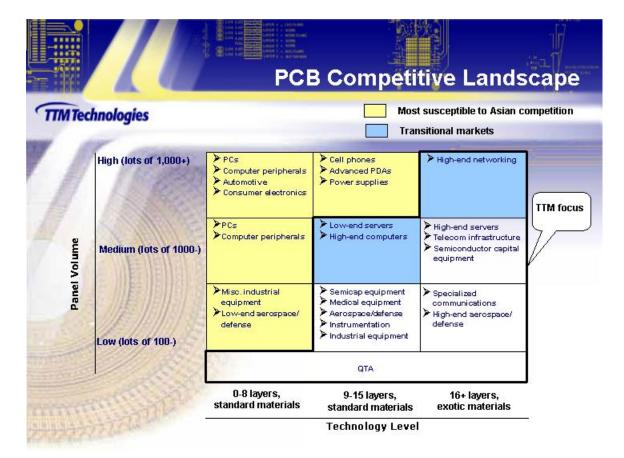


Consolidation Trends-U.S. PCB Market TTM Technologies Estimate of U.S. PCB fabricators with >\$100 million in 2002 revenues* Independent Integrated EMS **Public** Captive TTM > Tyco Sanmina DDI > IBM - Endicott Flextronics Photocircuits Merix Viasystems > 3M TTM continues to benefit from rapid consolidation in the U.S. PCB market *PCB Fab magazine, September 2002

Link to searchable text of slide shown above

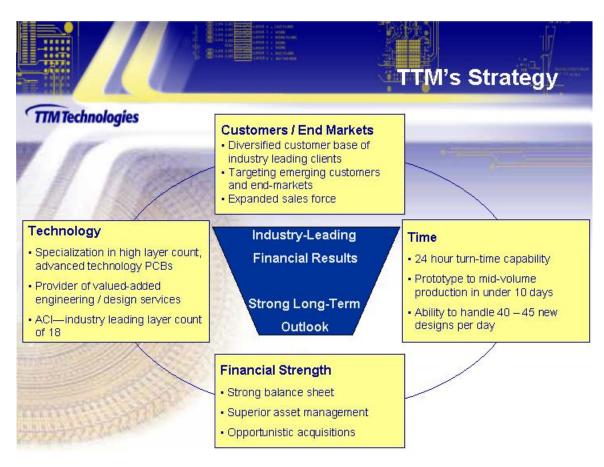


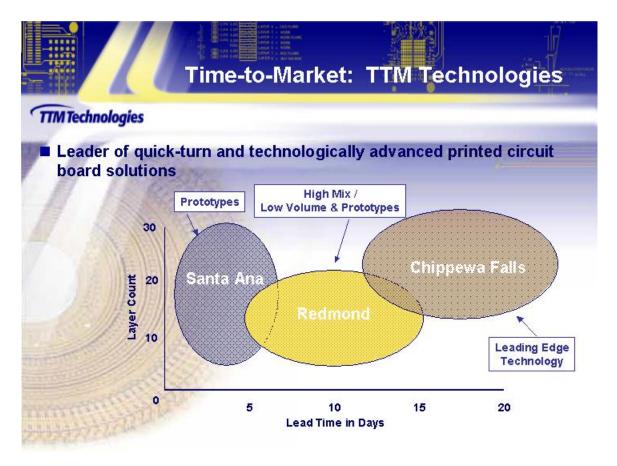
) Measured III 200 I Teveride.

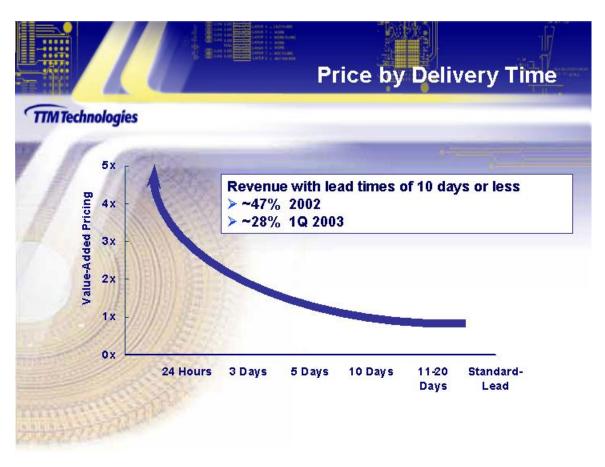




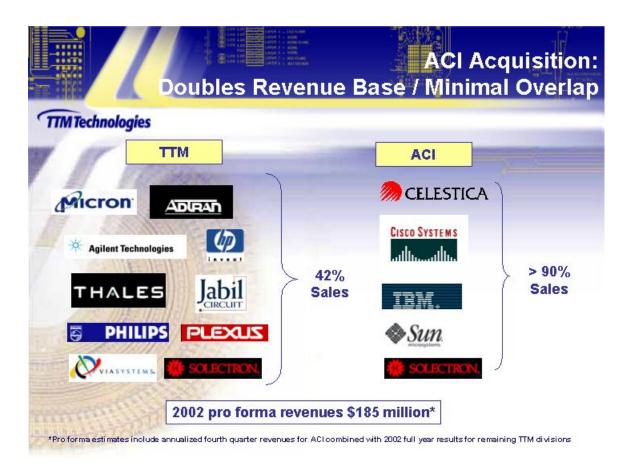


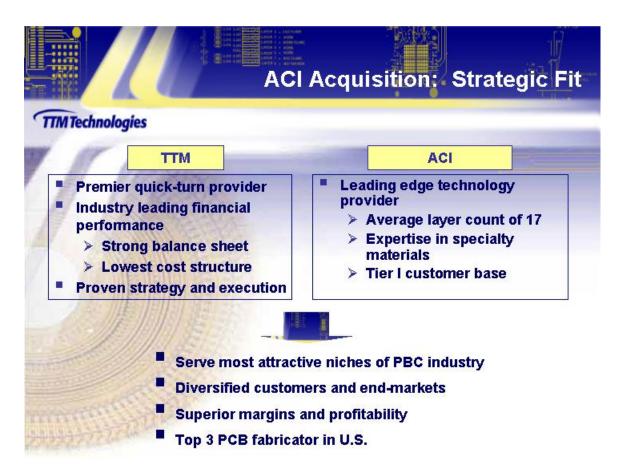


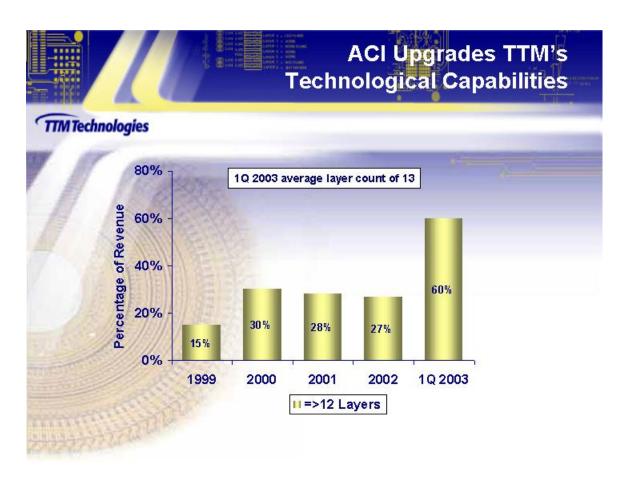




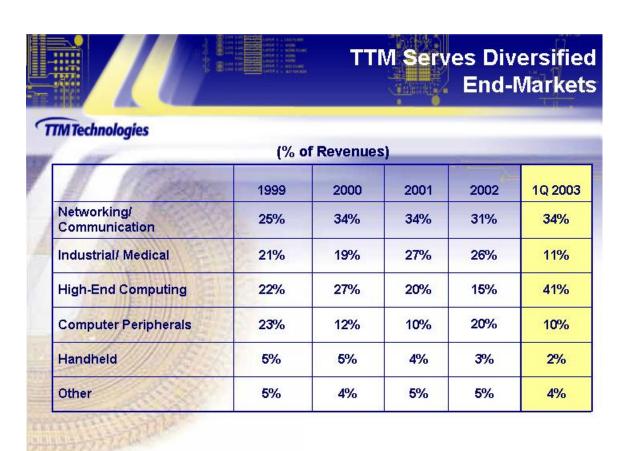
Recent Development: Advanced Circuits (ACI) Acquisition TTM Technologies Strategic fit Positions TTM as leading technology provider Creates one of three largest U.S. PCB fabricators Scale Favorably impacts material and capital costs New blue chip relationships Customers Minimal customer overlap drives cross selling opportunities Purchase price / **Attractive pricing** balance sheet Maintain strong balance sheet Financial Restructurings during 2002 Profitability expected in 2003 performance Mutually beneficial Core focus vs. orphan asset transaction





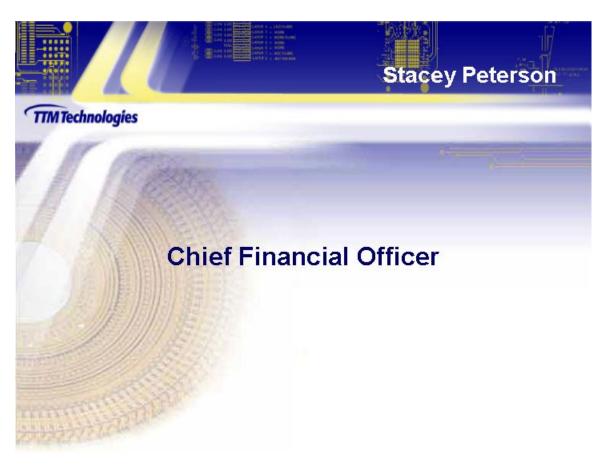






Future Acquisition Strategy TIMTechnologies Niche-oriented Expand quick-turn market share Expand specialty materials opportunities with military / aerospace end-market exposure Develop profitable Asian relationship Focus on PCB manufacturing

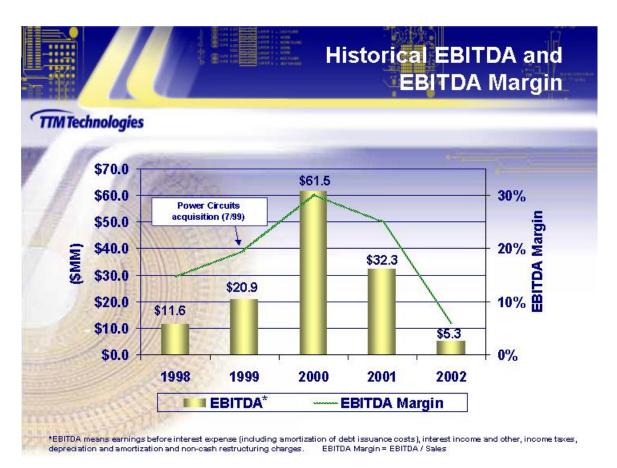
Link to searchable text of slide shown above

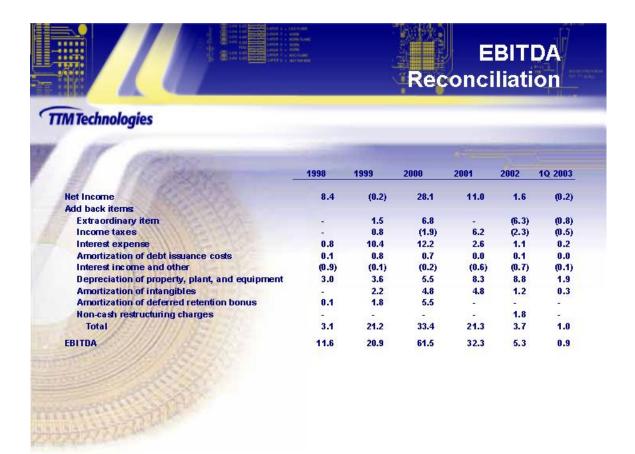




*Proformalestimates include annualized fourth quarter revenues for ACI combined with 2002 full year results for remaining TTM divisions

Link to searchable text of slide shown above





	ist Quarter 2	2003 Results
A Technologies		
llars in millions, except per share data	FIRST	UARTER
	2002	2003
Sales	\$23.7	\$39.6
Gross Profit	2.6	4.5
Operating Profit	(0.2)	(1.3)
Net Income Before Extraordinary*	(0.3)	(0.8)
EPS Before Extraordinary*	(\$0.01)	(\$0.02)
Operating Cash Flow	\$3.9	\$7.8
Inventory Turns	26x	14x

12/31/02	3/31/03
18.9	\$ 26.1
8.9	16.1
167.4	167.5
177.4	177.5
4.9x	5.8x
	18.9 8.9 167.4 177.4





Searchable text section of graphics shown above

[LOGO]

State of the North American PBC Market TMRC Conference May 6, 2003

Kent Alder

President and Chief Executive Officer

Safe Harbor Provision

During the course of this presentation, we will make projections or other forward-looking statements regarding future events or the future financial performance of the Company. We wish to caution you that such statements reflect only our current expectations, and that actual events or results may differ materially.

We refer you to the risk factors and cautionary language contained in the documents that the Company files from time to time with the Securities and Exchange Commission, specifically the Company's 10-K for our last fiscal year ended December 31, 2002. Such documents contain and identify important factors that could cause the actual results to differ materially from those contained in our projections or forward-looking statements. We undertake no obligation to update such projections or such forward-looking statements in the future.

For your convenient reference, a copy of this presentation on Form 8-K has been filed with the Securities and Exchange Commission and will be posted on our website.

North American PCB Market **Challenging Industry Trends**

- Prolonged downturn in electronics industry
- Increased competition
- Capacity reduction / consolidation
- North American PCB market transitioning to high mix, high complexity
- Several companies experiencing liquidity constraints / solvency issues

- Diversified customer base —well positioned for recovery
- Focus on cost management and operational efficiency
- Remaining competitors gaining customers / share
- Differentiation through technology and service
- Well capitalized players capturing share

Consolidation Trends-U.S. PCB Market

10 firms with sales > \$100 million

6 firms with sales \$50 - \$99.9 million

29 firms with sales \$20 - \$49.9 million

69 firms with sales \$10 - \$19.9 million

115 firms with sales \$5 - \$9.9 million

283 firms with sales < \$5 million

Increasing Market Share Among the Top Tier Firms 32% in 1990 45% in 2001

2001 Total U.S. Industry Sales: \$6.0 Billion

> Consolidation Trends-U.S. PCB Market

Estimate of U.S. PCB fabricators with >\$100 million in 2002 revenues*

Public	Independent Captive	Integrated EMS
• TTM	 Tyco 	• Sanmina
• DDI	 IBM — Endicott 	 Flextronics
• Merix	 Photocircuits 	 Viasystems
	• 3M	
	TTM continues to benefit from rapid con	nsolidation in the U.S. PCB market
*PCB Fab magazine September 2002	_	

Capacity Reductions: 30% - 35% Since 2001

Announced Plant Closings(1)	Estimated Capacity Shutdown(2)
2001 T. (1	01.655
2001 Total	\$1,655
2002	
Sanmina (NH)	\$70 — \$80
Teradyne (CA)	\$60 — \$70
Omni Circuits (CA)	\$30 — \$35
Honeywell (Various U.S. Sites)	\$60 — \$100
Tyco Advanced Quick (FL)	\$60
Paragon Circuits (CA)	\$20
Carolina Circuits (SC)	\$40
Viasystems (Toronto)	\$50
Printed Circuit Corp (MA)	\$40
Flextronics / Multek (CA)	\$40
TTM Burlington (WA)	\$30

Total \$2,155 - \$2,220

Source: Research analysts / company estimates.

- (1) Some facilities could re-open if demand improves, but this would require significant lead time and rebuilding of front-end capabilities.
- (2) Measured in 2001 revenue.

PCB Competitive Landscape

			TTM focus			
Panel volume	Most susceptible to Asian competition	Most susceptible to Asian competition	Transitional markets	Transitional markets		
High (lots of 1,000+)	 PCs Computer peripherals Automotive Consumer electronics	Cell phonesAdvanced PDAsPower supplies		High-end networking		
Medium (lots of 1000-)	• PCs • Computer peripherals		Low-end servers High-end computers	High-end servers Telecom infrastructure Semiconductor capital equipment		
Low (lots of 100-)	Misc. industrial equipment Low-end aerospace/defense		Semicap equipment Medical equipment Aerospace/ defense Instrumentation Industrial equipment	Specialized communications High-end aerospace/ defense		
	- 0.01		QTA			
	0-8 layers, standard			40.4		
	materials	9	-15 layers, standard materials Technology Level	16+ layers, exotic materials		

Advantages of Niche Focus -Time and Technology

- Faster Growth
 - Access to more diversified customer base
 - Critical to NPI across industries
- Superior margins and profitability
- Significant barriers to entry
 - Unique capabilities and culture for time
 - · Significant investment and expertise for technology
- · Few competitors in either target market segment

TTM's Strategy

TTM's Strategy

Industry-Leading Financial Results

Strong Long-Term Outlook

Customers / End Markets

- · Diversified customer base of industry leading clients
- Targeting emerging customers and end-markets
- Expanded sales force

Time

- 24 hour turn-time capability
- Prototype to mid-volume production in under 10 days

• Ability to handle 40 – 45 new designs per day	
Financial Strength	
Strong balance sheet	
Superior asset management	
Opportunistic acquisitions	
Technology	
Specialization in high layer count, advanced technology PCBs	
Provider of valued-added engineering / design services	
ACI—industry leading layer count of 18	
	Time-to-Market: TTM Technologies
Leader of quick-turn and technologically advanced printed circuit box	
	[CHART]
	Price by Delivery Time [CHART]
	[CHART]
	Recent Development:
0	Advanced Circuits (ACI) Acquisition
Strategic fitScale	 Positions TTM as leading technology provider Creates one of three largest U.S. PCB fabricators
Scare	Favorably impacts material and capital costs
• Customers	New blue chip relationshipsMinimal customer overlap drives cross selling opportunities
Purchase price / balance sheet	Attractive pricingMaintain strong balance sheet
Financial performance	Restructurings during 2002Profitability expected in 2003
Mutually beneficial transaction	Core focus vs. orphan asset
ттм	ACI Acquisition: Doubles Revenue Base / Minimal Overlap ACI
[LOGO] 42% Sales	[LOGO] >90% Sales
2002	pro forma revenues \$185 million*
*Pro forma estimates include annualized fourth quarter revenues for AC	CI combined with 2002 full year results for remaining TTM divisions
	ACI Acquisition: Strategic Fit
ттм	ACI
Premier quick-turn provider	Leading edge technology provider
Industry leading financial performance	 Average layer count of 17
Strong balance sheetLowest cost structure	 Expertise in specialty materials Tier I customer base
Proven strategy and execution	Tiel I customer ouse

- Serve most attractive niches of PBC industry
- Diversified customers and end-markets
- Superior margins and profitability
- Top 3 PCB fabricator in U.S.

ACI Upgrades TTM's Technological Capabilities

1Q 2003 average layer count of 13

[CHART]

Recognized by Industry Leaders

OEMs	EMS Providers
[LOGO]	[LOGO]

TTM Serves Diversified End-Markets

(% of Revenues)

	1999	2000	2001	2002	1Q 2003
Networking/ Communication	25 %	34%	34 %	31 %	34 %
Industrial/ Medical	21 %	19%	27 %	26%	11%
High-End Computing	22 %	27%	20 %	15 %	41 %
Computer Peripherals	23 %	12%	10 %	20%	10%
Handheld	5 %	5 %	4 %	3 %	2 %
Other	5 %	4 %	5 %	5 %	4 %

Future Acquisition Strategy

- Niche-oriented
 - Expand quick-turn market share
 - Expand specialty materials opportunities with military / aerospace end-market exposure
- Develop profitable Asian relationship
- Focus on PCB manufacturing

Stacey Peterson

Chief Financial Officer

Historical Sales Growth

[CHART]

^{*}Pro forma estimates include annualized fourth quarter revenues for ACI combined with 2002 full year results for remaining TTM divisions

[CHART]

*EBITDA means earnings before interest expense (including amortization of debt issuance costs), interest income and other, income taxes, depreciation and amortization and non-cash restructuring charges. EBITDA Margin = EBITDA / Sales

EBITDA Reconciliation

	1998	1999	2000	2001	2002	1Q 2003
Net Income	8.4	(0.2)	28.1	11.0	1.6	(0.2)
Add back items:						
Extraordinary item	_	1.5	6.8	_	(6.3)	(0.8)
Income taxes	_	0.8	(1.9)	6.2	(2.3)	(0.5)
Interest expense	0.8	10.4	12.2	2.6	1.1	0.2
Amortization of debt issuance costs	0.1	0.8	0.7	0.0	0.1	0.0
Interest income and other	(0.9)	(0.1)	(0.2)	(0.6)	(0.7)	(0.1)
Depreciation of property, plant, and equipment	3.0	3.6	5.5	8.3	8.8	1.9
Amortization of intangibles	_	2.2	4.8	4.8	1.2	0.3
Amortization of deferred retention bonus	0.1	1.8	5.5	_	_	_
Non-cash restructuring charges	_	_	_	_	1.8	_
Total	3.1	21.2	33.4	21.3	3.7	1.0
EBITDA	11.6	20.9	61.5	32.3	5.3	0.9

First Quarter 2003 Results

Dollars in millions, except per share data

		FIRST Q	UART	ER
		2002		2003
Sales	\$	23.7	\$	39.6
Gross Profit		2.6		4.5
Operating Profit		(0.2)		(1.3)
Net Income Before Extraordinary*		(0.3)		(0.8)
EPS Before Extraordinary*	\$	(0.01)	\$	(0.02)
Operating Cash Flow	\$	3.9	\$	7.8
Inventory Turns		26x		14x

 $^{*1}Q\ 2003\ results\ includes\ \$203,\!000\ restructuring\ charge\ and\ are\ before\ extraordinary\ gain\ of\ \$824,\!000,\ related\ to\ acquisition\ of\ ACI$

Capitalized for Future Growth

	12/3	12/31/02		
Cash	\$	18.9	\$	26.1
Net Cash (Debt)		8.9		16.1
Total Shareholders' Equity		167.4		167.5
Total Capitalization		177.4		177.5
Interest Coverage*		4.9x		5.8x

^{*}EBITDA / Interest Expense, includes cash restructuring charges of \$2.0 M for 2002 and \$203,000 for 1Q 2003

•	ACI acquisition establishes TTM as leading technology provider
•	Well-positioned for industry recovery as one of the largest U.S. PCB fabricators
•	Investing in "time" and "technology"
•	Positioned to gain market share as industry "winner"
•	Strong balance sheet
_	

[LOGO]